



## Exercise 2

1. Consider the circuit of Fig.1.1.

a) Using the simple model with  $V_{\text{Don}} = 0.7\text{V}$ , solve for  $I_D$ ;

b) Find  $I_D$  and  $V_D$  using the ideal diode equation. Use  $I_S = 10^{-14}\text{A}$  and  $T=300\text{K}$ .

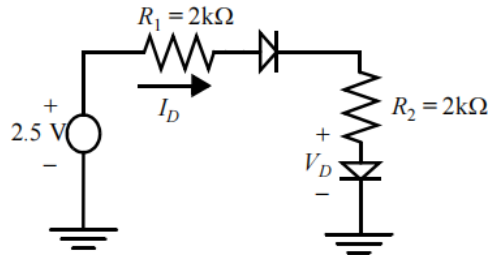


Fig.1.1

2. For the circuit in Fig.1.2,  $V_s=3.3\text{V}$ . Assume  $A_D = 12\text{ }\mu\text{m}^2$ ,  $\phi_0 = 0.65\text{V}$ , and  $m=0.5$ ,  $N_A = 2.5 \times 10^{16}\text{ cm}^{-3}$ ,  $N_D = 5 \times 10^{15}\text{ cm}^{-3}$  and  $\epsilon_{si} = 11.7\epsilon_0$ ,  $\epsilon_0 = 8.85 \times 10^{-12}\text{F/m}$ .

a) Is the diode forward- or reverse-biased?

b) Find  $I_D$  and  $V_D$ ;

c) Find the depletion region width,  $W_j$ , of the diode;

d) Use the parallel-plate model to find the junction capacitance,  $C_j$ ;

e) Set  $V_s = 1.5\text{V}$ . Again using the parallel-plate model, explain qualitatively why  $C_j$  increases.

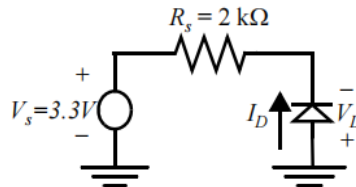


Fig.1.2

3. Fig.1.3 shows NMOS and PMOS devices with drains, source, and gate ports annotated. Determine the operation region (saturation, linear, or cutoff) and the drain current  $I_D$  for each of the biasing configurations given in table. Assume the model parameters from Table.1.1,  $V_{BS}=0$  and  $W/L = 1$ ,  $L=1\text{ }\mu\text{m}$  fill the table

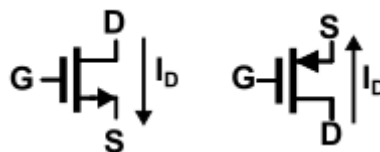


Fig.1.3

	$V_{GS}(\text{V})$	$V_{DS}(\text{V})$	Operation region	$I_D (\mu\text{A})$
NMOS	2.5	2.5		
	3.3	2.2		
	0.6	0.1		
PMOS	-0.5	-1.25		
	-2.5	-1.8		
	-2.5	-0.7		

4. An NMOS device is plugged into the test configuration shown below in Fig .1.4 The input  $V_{in}$  is 2V. The current source draws a constant current of  $50 \mu\text{A}$ .  $R$  is a variable resistor between  $10\text{k}\Omega$  and  $30 \text{k}\Omega$ . Transistor M1 has following transistor parameters:  $k' = 110 \mu\text{A}/\text{V}^2$ ,  $V_T = 0.7\text{V}$ , and  $V_{DSAT} = 0.6\text{V}$ , and has a  $W/L = 2.5\mu/0.25\mu$ . For simplicity, the body effect and channel length modulation can be neglected, i.e  $\lambda=0$ ,  $\gamma=0$ .

- a) When  $R = 10\text{k}\Omega$  find the operation region,  $V_D$  and  $V_S$ .  
b) For the case of  $R = 10\text{k}\Omega$ , would  $V_S$  increase or decrease if  $\lambda \neq 0$ . Explain qualitatively.

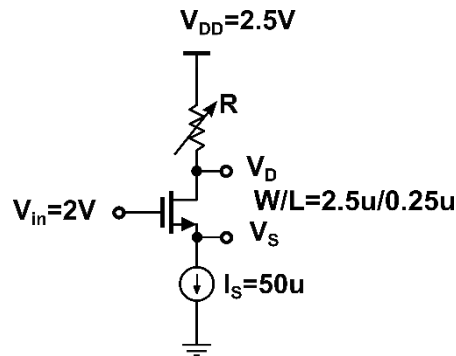


Fig.1.4

### Thinking Questions(optional)

5. Show that two MOS transistors connected in parallel with channel widths of  $W_1$  and  $W_2$  and identical channel lengths of  $L$  can be modeled as one equivalent MOS transistor whose width is  $W_1+W_2$  and whose length is  $L$ , as shown in Fig.1.5 Assume the transistors are identical except for their channel widths.

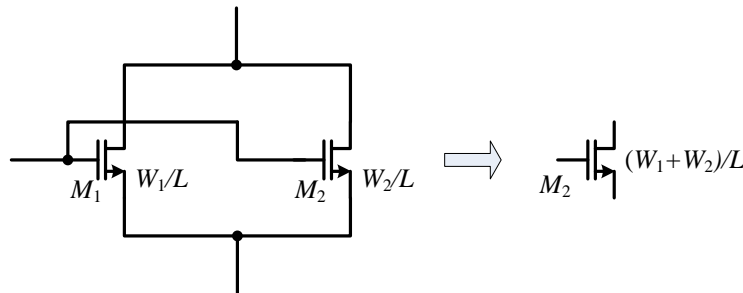


Fig.1.5

6. Show that two MOS transistors connected in series with channel lengths of  $L_1$  and  $L_2$  and identical channel widths of  $W$  can be modeled as one equivalent MOS transistor whose width is  $W$  and whose length is  $L_1+L_2$ , as shown in Fig. 1.6. Assume the transistors are identical except for their channel lengths. Ignore the body effect and channel-length modulation.

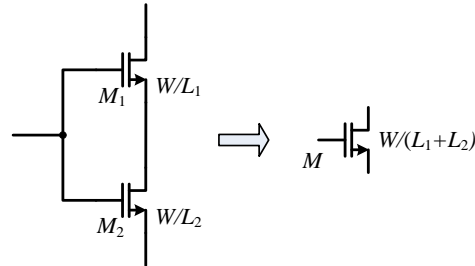


Fig.1.6

Table.1.1

Parameter Symbol	Parameter Description	Typical Parameter Value		Units
		n-Channel	p-Channel	
$V_{T0}$	Threshold voltage ( $V_{BS}=0$ )	0.7	-0.7	V
$K'$	Transconductance parameter ( in saturation)	110.0	50.0	$\mu\text{A}/\text{V}^2$
$\gamma$	Bulk threshold parameter	0.4	0.57	$\text{V}^{1/2}$
$\lambda$	Channel length modulation parameter	0.04 (L=1 $\mu\text{m}$ ) 0.01 (L=2 $\mu\text{m}$ )	0.05 (L=1 $\mu\text{m}$ ) 0.01 (L=2 $\mu\text{m}$ )	$\text{V}^{-1}$
$2 \Phi_F $	Surface potential at strong inversion	0.7	0.8	V

$$*K' = \frac{1}{2} \mu C_{ox}$$